PATENT ASSIGNMENT

Electronic Version v1.1 Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
Hanyi Ding	06/18/2008
Wayne H Woods Jr	06/18/2008

RECEIVING PARTY DATA

Name:	International Business Machines Corporation	
Street Address:	New Orchard Road	
City:	Armonk	
State/Country:	NEW YORK	
Postal Code:	10504	

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	12144684

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NAME OF SUBMITTER: Anthony J. Canale

Total Attachments: 1

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\$40.00

PATENT REEL: 021139 FRAME: 0600

ASSIGNMENT

INVENTOR AND CITY

Whereas, we

(1) **Hanyi DING**County of Chittenden

of Essex Junction, and State of Vermont,

and (2) Wayne H. WOODS, JR.

County of Chittenden

of Burlington, and State of Vermont.

have invented certain improvements in

DESIGN STRUCTURE, STRUCTURE AND METHOD FOR PROVIDING AN ON-CHIP VARIABLE DELAY TRANSMISSION LINE WITH FIXED CHARACTERISTIC IMPEDANCE

DATES THAT INVENTORS SIGNED THE DECLARATION and executed, respectively, a United States patent application therefore on

(1) <u>06/18</u>, 2008, (2) <u>06/19</u>, 2008,

Whereas, INTERNATIONAL BUSINESS MACHINES CORPORATION, a corporation of New York, having a place of business at Armonk, New York 10504, (hereinafter called IBM), desires to acquire the entire right, title and interest in the said application and invention, and to any United States and foreign patents to be obtained therefore;

Now therefore, for a valuable consideration, receipt whereof is hereby acknowledged, we, the above named, hereby sell, assign, and transfer to IBM, its successors and assigns, the entire right, title and interest in the said application and invention therein disclosed for the United States and foreign countries, and in all foreign countries, and all rights of priority resulting from the filing of said United States application, and we request the Commissioner of Patents to issue any Letters Patent granted upon the inventions set forth in said application to IBM, its successors and assigns; and we hereby agree that IBM may apply for foreign Letters Patent on said invention and we will execute all papers necessary in connection with the United States and foreign applications when called upon to do so by IBM.

Signed and sealed:

(1) Harrif

on <u>06/18</u>,₂₀₀₈

Hanyi DING

(2) By H. Lots Jr.

on <u>06/18</u>, 2008

Wayne H. WOODS, JR.

RECORDED: 06/24/2008

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PATENT REEL: 021139 FRAME: 0601